



HI ← ECN3.

Target materials R&D & procurement

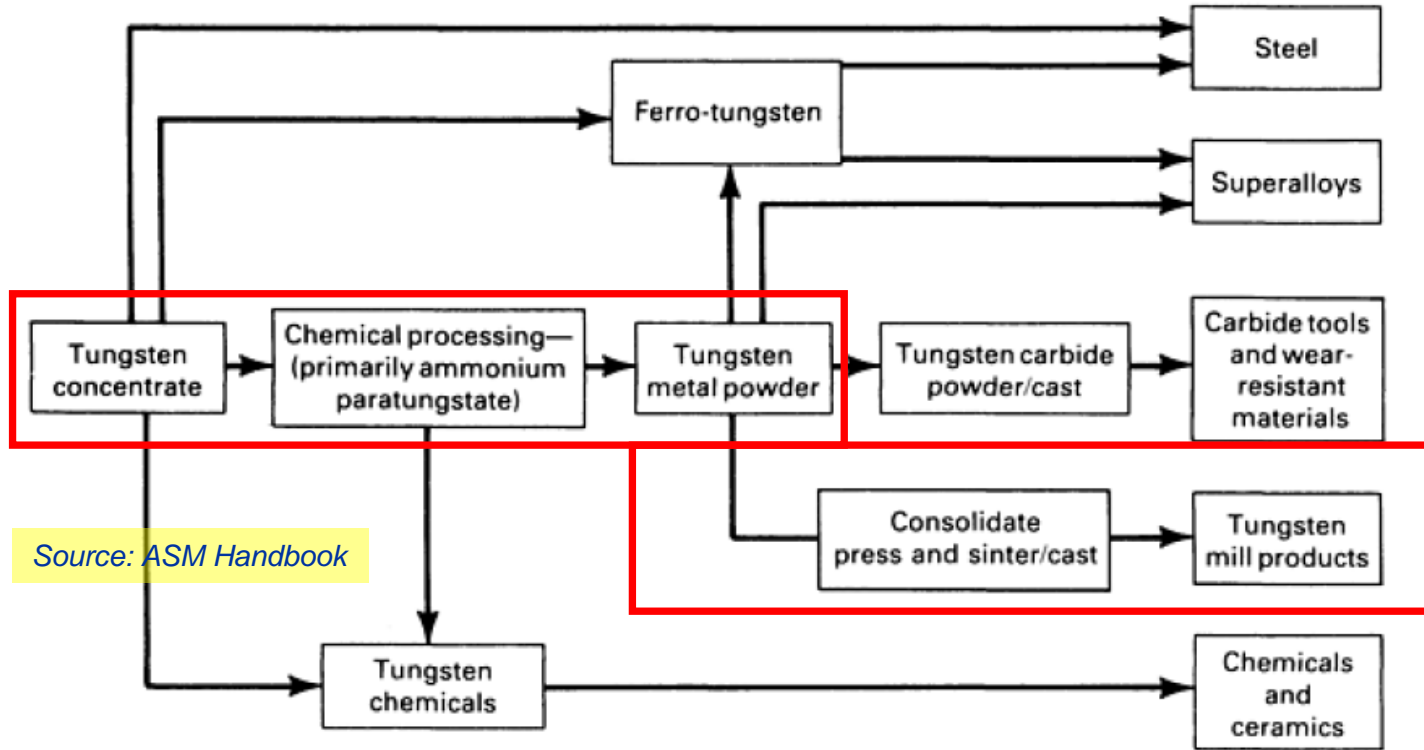
- Ongoing and required material R&D to meet the project requirements
- Palette of tests for the material target – and why
- Explain the choice of hot rolled W as baseline, procurement considerations
- Radiation damage considerations on materials – do we care?

Stefano Sgobba, Katie Elizabeth Buchanan, Patrick Michael Curran, Enrique Rodriguez Castro, Ignacio Aviles Santillana, Ana Teresa Perez Fontenla, Marlini Simoes

04/03/2025



Pure W - Metallurgy and processing background



Source: ASM Handbook

Courtesy of Plansee SE



Tungsten mill products divided into three distinct groups on the basis of recrystallization behavior:

- 1) EB-melted, zone-refined, or arc-melted unalloyed tungsten
 - Exhibit equiaxed grain structures upon primary recrystallization.
 - Recrystallization T and grain size both decrease with increasing deformation
 - In EB-melted tungsten wire, the recrystallization T can be 900 °C or lower
- 2) Commercial grade or undoped P/M tungsten, sensitive to purity
 - Like the first group, these materials exhibit equiaxed grain structures, but their recrystallization temperatures are higher than those of the first-group materials.
 - Also, these materials do not necessarily exhibit decreases in recrystallization temperature and grain size with increasing deformation
 - In commercially pure (undoped) tungsten Recrystallization T can be as high as 1205 to 1400 °C
- 3) The third group of materials consists of doped tungsten

Pure W - Metallurgy and processing background

Table 22 Typical purity of the three commercial products

Impurity element	Concentration, ppm, in tungsten		
	Electron beam zone refined	Undoped	Doped
Iron	1	10	11
Nickel	2	5	5
Silicon	5	21	47
Aluminum	<2	<5	15
Potassium	<1	12	91
Oxygen	10	27	36
Carbon	20	31	24

QM1 / PSE-605-PS-016 / part 100 / Version 04

W-Sheet



PS - PRODUCTSPECIFICATION

4 / 6

This document is subject to electronic version control - confirm version status before using.

3 Chemical composition

Main and Minor Components	Plansee Content		Standard	EU-Directive
	Max. Values [µg/g]	Min. 99,97 % ^{b)}		
W	99.99 % ^{b)}	Min. 99,97 % ^{b)}	Balance	-
Impurities	Typical	Guaranteed	Max. Values [µg/g]	Max. Values [µg/g]
Al	1	15	-	-
Cr	3	20	-	-
Cu	1	10	-	-
Fe	8	30	100	-
K	1	10	-	-
Mo	12	100	-	-
Ni	2	20	100	-
Si	1	20	100	-
C	6	30	100	-
H	-	5	-	-
N	1	5	100	-
O	2	20	100	-
Cd	1	5	-	100
Hg	-	1	-	1000
Pb	1	5	-	1000
Cr (VI)	-	-	-	1000
Organic Impurities (e.g. PBB, PBDE, PFOS, PFOA)	-**)	-**)	-	1000

a) EU-directives 2015/863/EU, 2011/65/EU and 2000/53/EC.

b) Metallic purity without Mo

***) The presence of Cr (VI) and organic impurities can definitely be excluded because of the production process (multiple heat treatments at temperatures above 1000 °C in H₂-atmosphere).

The chemical composition is checked by means of random sampling. The sampling inspection plan, analysis and evaluation methods are determined in the internal instruction PSE-020-WI-003. The application of the measured values for the chemical analysis is defined in PSE-600-WI-001.

Remarks: The specified physical and chemical characteristics are disclosed not regarding measurement accuracy.

PLANSEE

Plansee SE, Metallwerk Plansee-Straße 71, 6600 Reutte, Austria

Shipping address
CERN
Réception PREVESSIN
Site de Preveessin
01631 CERN CEDEX
FRANCE

TEST-REPORT 820532318 000010
acc. to EN 10204-2.2

Date: Oct 15, 2024
Order number: 49202395 / 10 Sep 10, 2024
Delivery: 820532318 / 10
Total quantity: 1 PCE
Total weight: 13.211 KG

Customer information

Customer number 2011844
PO number CA1221931 Sep 9, 2024

Internal information

Material: 15028974
Basic material: W
Description: W Sheet 5 x 370 x 370 mm
Batch: 0095159413
Specification: PSE-605-PS-016/100/04

GUARANTEED REQUIREMENTS:
Hardness HV EN ISO 6507-1: =>450
Density EN ISO 3369: >19,20 g/cm³

GUARANTEED CHEMICAL COMPOSITION: (determined in PSE-020-WI-003)

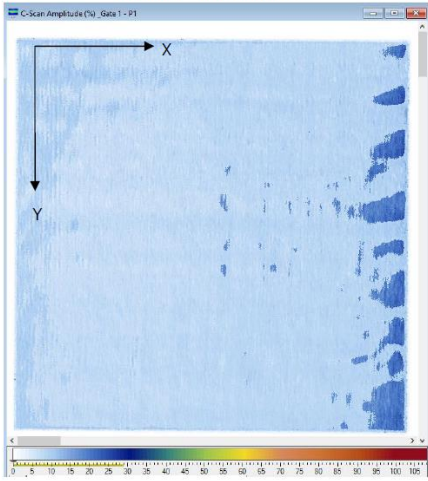
W	min. 99,97 %**	Cr	max. 20 µg/g	Cu	max. 10 µg/g
Al	max. 15 µg/g	K	max. 10 µg/g	Ni	max. 20 µg/g
Fe	max. 30 µg/g	Mo	max. 100 µg/g	C	max. 30 µg/g
Si	max. 20 µg/g	N	max. 5 µg/g	O	max. 20 µg/g
H	max. 5 µg/g	Hg	max. 1 µg/g	Pb	max. 5 µg/g
Cd	max. 5 µg/g				

***) Metallic purity without Mo
Cr(VI) + Organic impurities (e.g. PBB, PBDE, PFOS, PFOA)*
The requirements of the EU-directives 2015/863/EU, 2011/65/EU and 2000/53/EC for the restriction of hazardous substances (RoHS) are fulfilled.
*) The presence of Cr(VI) and organic impurities can be excluded definitely because of the production process (multiple heat treatment at temperatures above 1000°C in H₂-atmosphere).

- HR product ordered in 5 mm and 17 mm thickness
- Limited availability in heavy gauges with guaranteed properties - due to a minimum reduction to be provided to achieve final properties

No indications above TFP 1.2mm detected.
All pieces are acceptable to EN 4050-4 Class 5

Amplitude of defect echoes



Amplitude of backwall echo



↑ UT results on the 5 mm plate: excellent homogeneity and high acceptance level (to 1.2 mm FBH equivalent), [EDMS 3190589](#)

Pure W - Metallurgy and processing background

To the extent of the inspections performed, dimensions and tolerances conforming to ASTM B760, see [EDMS 3180443](#)

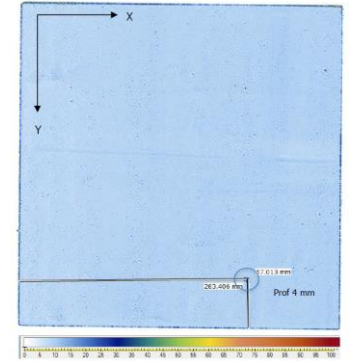
HR 5 mm ↓ and 17 mm thick → plates ordered and received from Plansee



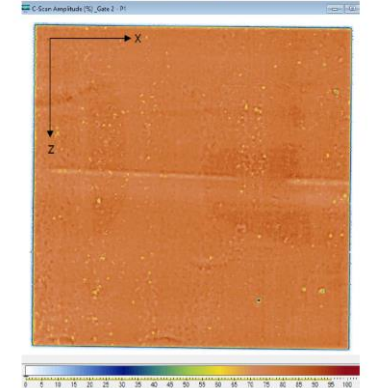
No indications above FBH 1.2mm detected.
The piece is acceptable to EN 4050-4 Class 5
Several reflectors with equivalent reflectivity up to FBH $\phi 0.7$ mm are observed at depth ~ 4 mm from the label face

C-SCAN RESULTS - amplitude part N°1

Amplitude of defect echoes

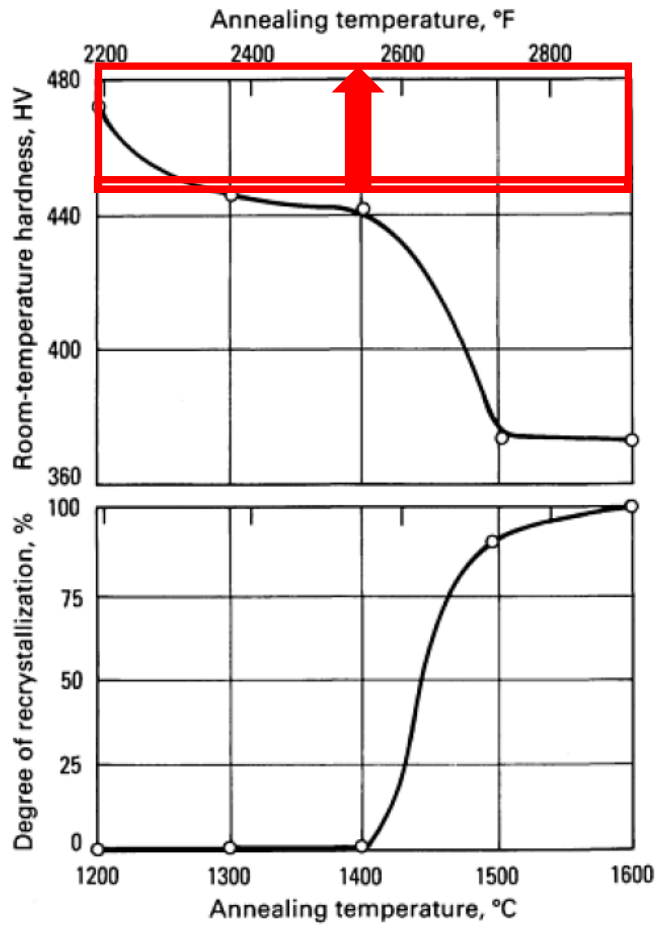


Amplitude of backwall echo



↑ UT results on the 17 mm plate: excellent homogeneity and high acceptance level (to 0.8 mm FBH equivalent), [EDMS 3237640](#)

Pure W - Metallurgy and processing background

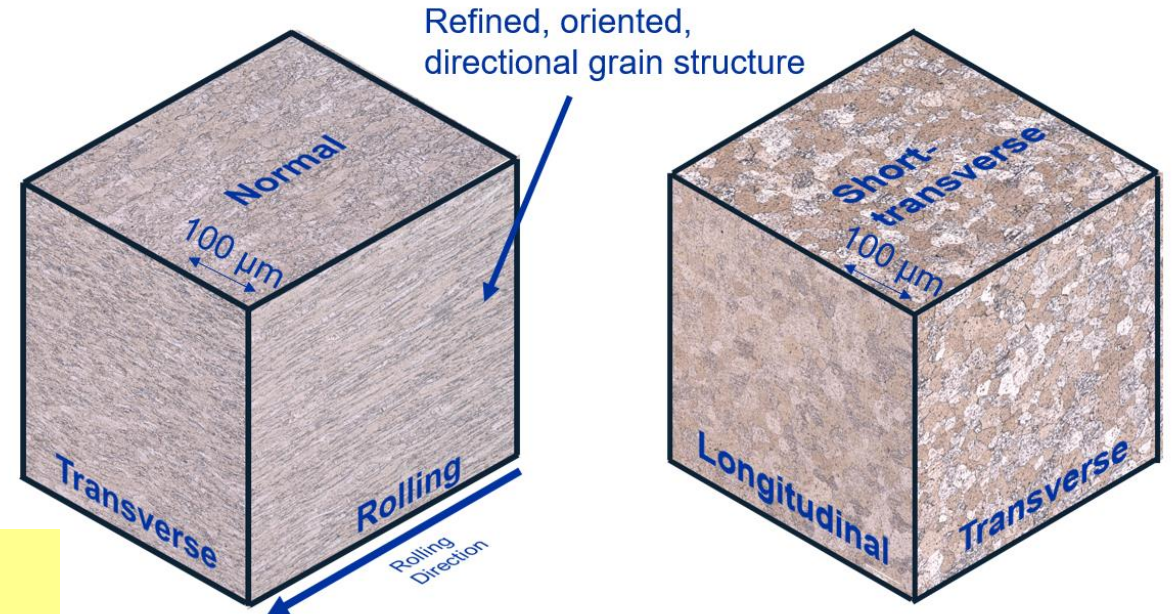


GUARANTEED REQUIREMENTS		
Hardness HV	EN ISO 6507-1:	=>450
Density	EN ISO 5353:	> 19,26 g/cm ³

GUARANTEED CHEMICAL COMPOSITION: (determined in PSE-020-WI-003)

W	min.	99,97 %**	Cr	max.	20 µg/g	Cu	max.	10 µg/g
Al	max.	15 µg/g	K	max.	10 µg/g	Ni	max.	20 µg/g
Fe	max.	30 µg/g	Mo	max.	100 µg/g	C	max.	30 µg/g
Si	max.	20 µg/g	N	max.	5 µg/g	O	max.	20 µg/g
H	max.	5 µg/g	Hg	max.	1 µg/g	Pb	max.	5 µg/g
Cd	max.	5 µg/g						

***) Metallic purity without Mo
 Cr(VI) + Organic impurities (e.g. PBB, PBDE, PFOS, PFOA)*
 The requirements of the EU-directives 2015/863/EU, 2011/65/EU and 2000/53/EC for the restriction of hazardous substances (RoHS) are fulfilled.
 *) The presence of Cr(VI) and organic impurities can be excluded definitely because of the production process (multiple heat treatment at temperatures above 1000°C in H₂-atmosphere).



Benjamin Corbett,
<https://indico.cern.ch/event/1480601/>

Fig. 26 Recrystallization behavior of undoped tungsten bar

	HV1	SD	Grain Size Number
Transverse	490.6	6.6	10
Normal	485.3	8.4	9.5
Rolling	500.9	17.8	10.5

5mm rolled Hardness and Grain Size

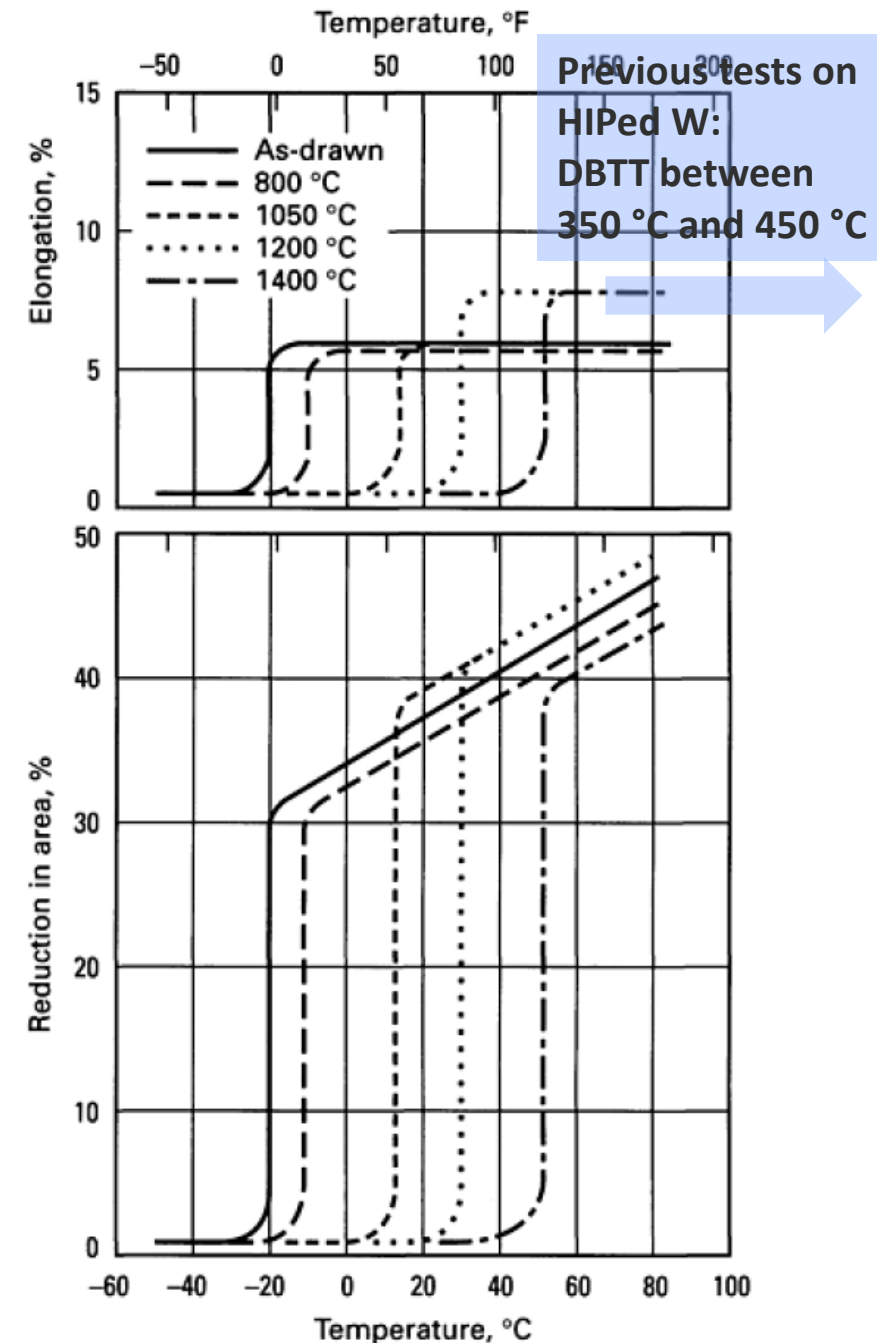
	HV1	SD	Grain Size Number
Longitudinal	350.4	8.7	7
Transverse	350.6	5.2	7
Short-transverse	353.14	9.5	7

Forged Hardness and Grain Size

Pure W - Metallurgy and processi

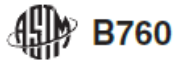
Remarks: Upon request, the tungsten sheets are delivered stress-relieved annealed. We point out that the stress-relieved-annealing may lead to a material specific embrittlement

- **Recrystallized tungsten** undergoes a ductile-to-brittle transition **above 205 °C** .
- Only by **heavy warm or cold working** is the **DBTT lowered to below room temperature**
- **Annealing** raises the **DBTT** of cold-worked tungsten until it approaches that of **recrystallized material**
- The exact ductile-to-brittle transition temperature is influenced by many factors, including **grain size**, strain rate, and **impurity levels**
- The DBTT **decreases with grain size** unless the grains are larger than 1 mm in diameter.
- The DBTT also drops with increases in strain rate, but it **climbs rapidly as impurity levels increase**.
- Like all brittle metals, **tungsten is very notch sensitive**. Therefore, **removal of even minute surface flaws by grinding**, oxidizing, or **electrolytic polishing** prior to service improves ductility and lowers the DBTT



Pure W flat products – Standard framework

This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.



Designation: B760 – 07 (Reapproved 2019)

Standard Specification for Tungsten Plate, Sheet, and Foil¹

This standard is issued under the fixed designation B760; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

3.2 Product Forms:

3.2.1 *foil, n*—a flat product less than 0.005 in. (0.13 mm) in thickness.

3.2.2 *plate, n*—a flat product 0.188 in. (4.75 mm) or more in thickness.

3.2.3 *sheet, n*—a flat product from .005 in. (0.13 mm) to 0.187 in. (4.75 mm) in thickness.

TABLE 1 Chemical Composition/Check Analysis

Element	Composition, max, %	Permissible Variations in Check Analysis, %
C	0.010	±0.002
O ^A	0.010	+ 10 % relative
N	0.010	+ 0.0005
Fe	0.010	+ 0.001
Ni	0.010	+ 0.001
Si	0.010	+ 0.001

^A If chemical analysis is performed on a sample from the powder blend used to make the finished product, oxygen will be reported for information only.

7. Metallurgical Condition

7.1 Plate, sheet and foil shall be furnished in one of the following conditions as designated on the purchase order:

Form	Metallurgical Condition
Plate	hot-rolled
	hot-rolled, stress-relieved
Sheet	hot-rolled
	hot-rolled, stress-relieved
	cold-rolled
Foil	cold-rolled, stress-relieved
	cold-rolled
	cold-rolled, stress-relieved

7.2 Other conditions can be specified as agreed upon between the purchaser and the manufacturer at the time of purchase.

10.4 Material may be supplied with as-rolled, as-cleaned, as-machined, or as-ground finish.



Ongoing and required material R&D to meet the project requirements

Operating conditions:

- RT to 400°C
- Stresses: -100 MPa to 150 MPa
- Fatigue life of 10^7 cycles
- Irradiation: approximately 1.2 - 1.6 dpa (< 2 dpa)
- Individual block height: 17 mm (as HR?) to 350 mm (as HIPed) thick and 250 mm diameter (present baseline)
- Chemical additions from He: 143-220 ppm(at)
- Beam Parameters: sigma 8 mm (possibly 16 mm)
- As HR and HR + HIPed properties are relevant
- HR product form looks a reasonable choice – availability in heavy gauges with guaranteed properties limited

J. Habainy et al. / Journal of Nuclear Materials 465 (2015) 438–447

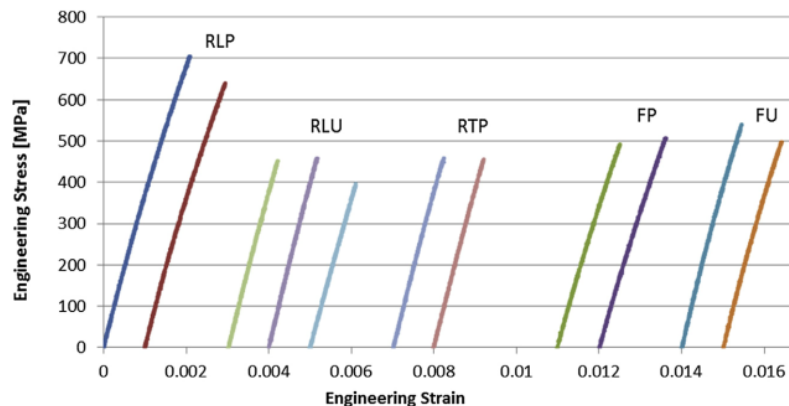


Fig. 3. Tensile data for rolled and forged specimens at 25 °C.

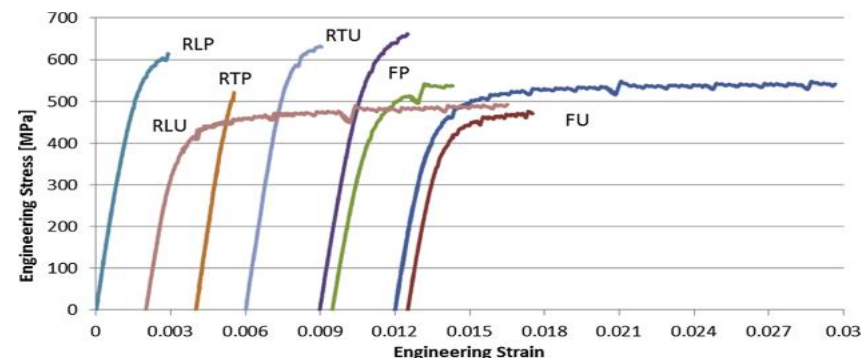


Fig. 4. Tensile data for rolled and forged tungsten at 280 °C.

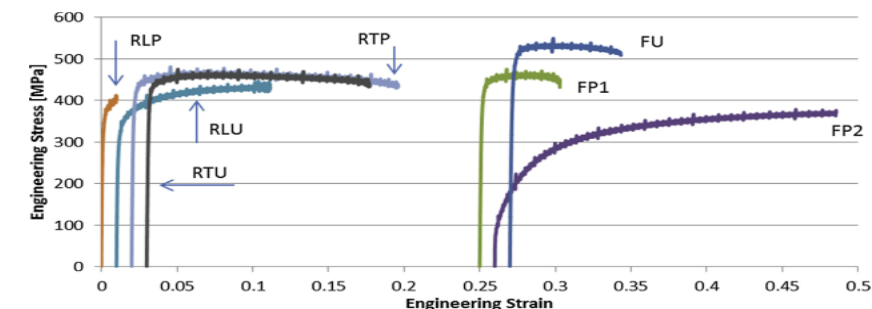


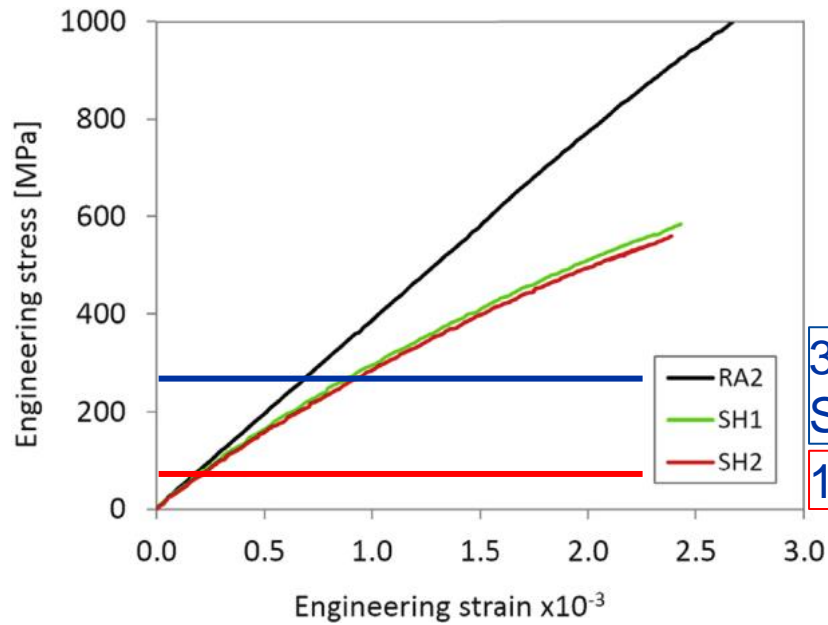
Fig. 5. Tensile data for rolled and forged tungsten at 480 °C.

Ongoing and required material R&D to meet the project requirements

Limited mechanical properties in SH material

- Limited fatigue endurance limit
- Limited yield

J. Habainy, S. Iyengar, Y. Lee, Y. Dai.
<https://doi.org/10.1016/j.jnucmat.2017.10.061>



J. Habainy, Y. Lee, Y. Dai, S. Iyengar,
<https://doi.org/10.1016/j.jnucmat.2015.06.032>

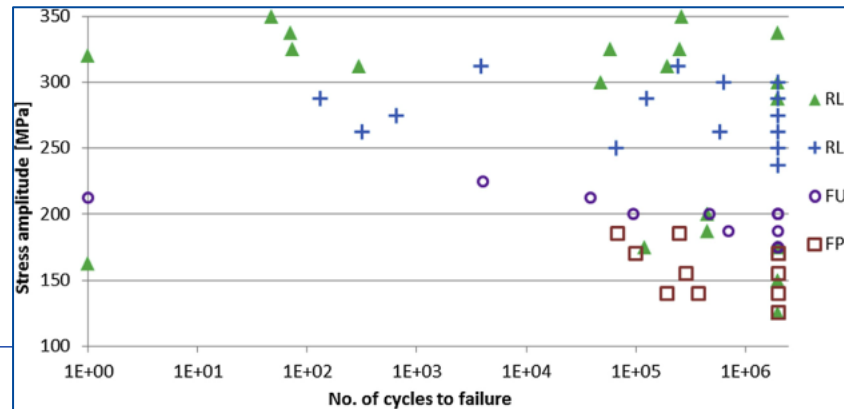
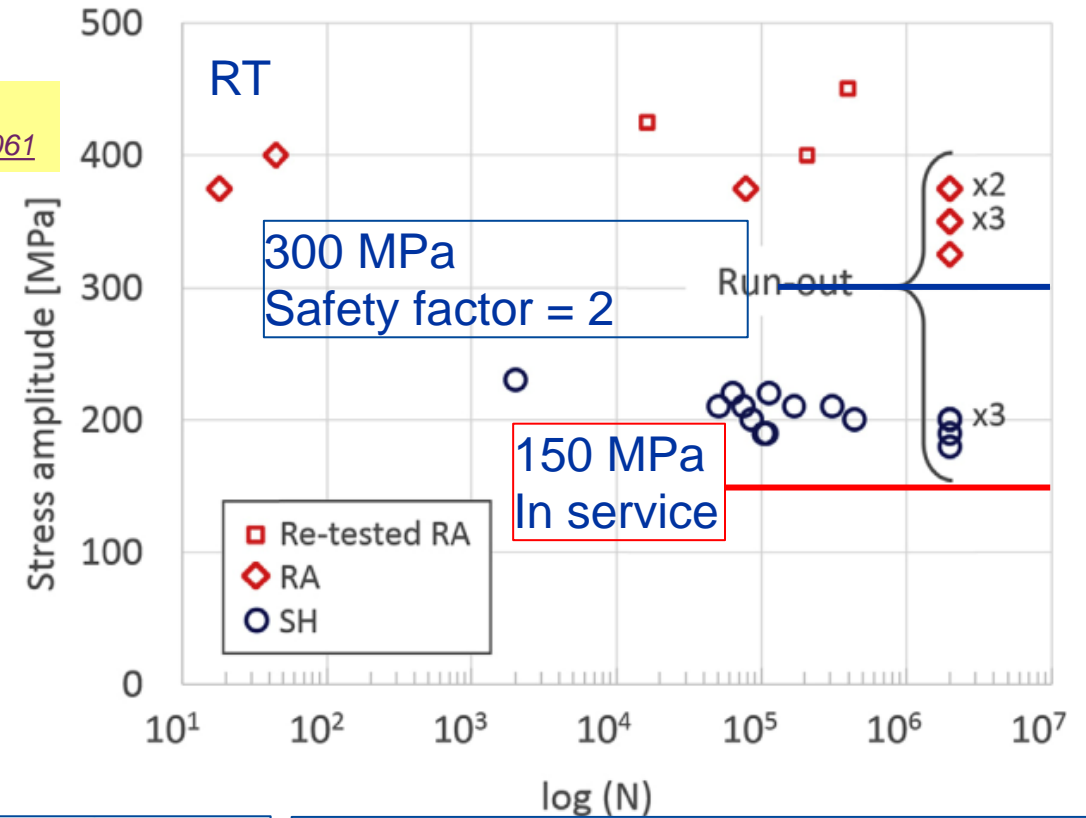


Fig. 8. Wöhler diagram for rolled and forged tungsten at 25 °C.

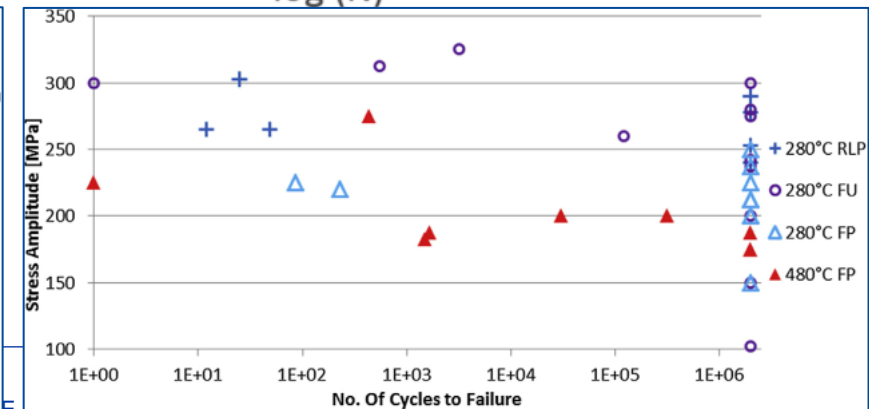


Fig. 9. Wöhler diagram for rolled and forged tungsten at 280° and 480 °C.

Palette of tests for the material target – and why

Mechanical testing:

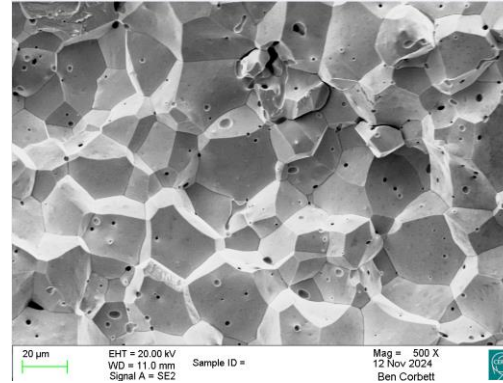
- Charpy impact toughness testing of the base material, from RT to 600 °C
- RT & high T tensile testing with possibility of an inert or vacuum atmosphere
- As above, fatigue testing
- Tensile testing of the adhesion strength of the HIP bonded plates W-W & W-Ta-W.
- Material hardness (as a function of T?)

Ongoing in house on HR plates:

- A complete grain size analysis
- Grain orientation analysis
- Recast layer analysis & post cut processing
- Density evaluation
- Microstructural changes of the base material during the heating exposure/HIPing process

Oxidation studies:

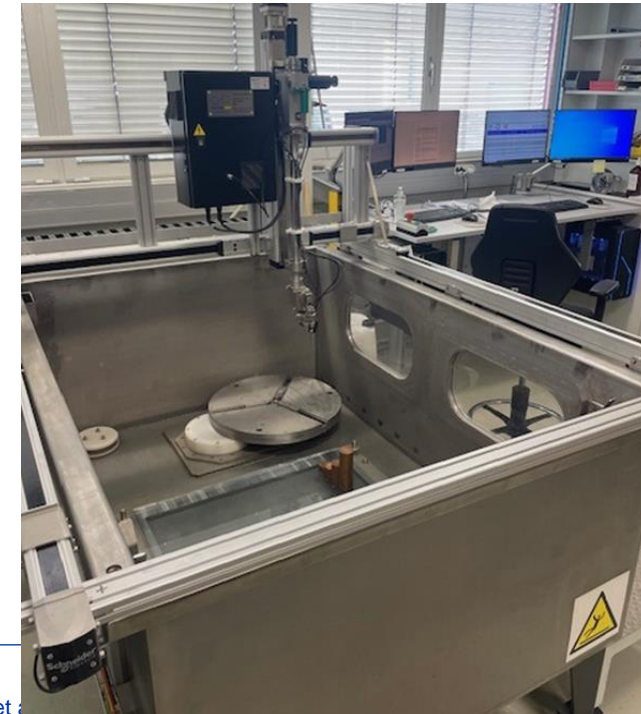
- in relation to NDT
- and operating environment



Material characterization

Metrology & NDT

- Immersion UT of all incoming plates EN 4050-4
- Flatness evaluation ASTM B760-07
- Roughness evaluation



Palette of tests

Oxidation studies vs. operating environment

- similar behaviour expected as reported for Mo ⇒
- cleaning of W is desirable to remove compounds that could cause carbon contamination during exposure to a heat cycle
- a variety of cleaning agents may be used to remove oils and hydrocarbons (vapor degreasing and hand or automatic washing with detergent solutions)
- chemical cleaning only needed for heavily oxidised surfaces

See J. Habainy et al., Formation of oxide layers on tungsten at low oxygen partial pressures:

- **In Ar gas with a maximum oxygen partial pressure of 5 ppm, a thin and adherent oxide film was observed to form on the surface of tungsten specimens even at 500 °C**
- For the operation of the ESS spallation facility, it is important to note **that tungsten can be oxidized in environments with low oxygen partial pressures at T as low as 400 °C**
- **Below 500 °C it is expected that the oxide formed will be of the protective type**
- **However**, considering that the tungsten will be cooled by a massive helium flow with a flux of 3 kg/s at 1.1 MPa, **surface erosion of the oxide scale was a concern**
- Erosion experiments were performed to study the adhesion of the oxide formed on tungsten at 500 °C
- The sample, pre-oxidized for 1 h in a He-0.5%O₂ gas mixture, showed no signs of erosion caused by the helium jet
- Still, the **spalling of the oxide layer** due to beam pulse and beam trip induced thermal cycling, and fatigue, during five years of target lifetime, **remains an issue**
- Also of concern is the possibility of tungsten oxide sublimation in accidental cases such as over-focused beam combined with loss of helium confinement.
- **To minimize such risks, the target primary cooling loop will be purified and the impurity levels will be monitored during operation.**

Atmosphere																							
Oxygen	At higher pressures, formation of solid and liquid oxides; evaporation of volatile oxides resulting in weight losses. At low pressures, no surface oxide scales; evaporation of volatile oxides, resulting in steady states with temperature- and pressure-dependent weight losses. C-containing Mo is degassed by CO formation	Complex oxidation behavior showing weight gains and weight losses Formation of volatile oxides, possible selective evaporating; internal oxidation																					
Water vapor	At high pressures, oxidation and evaporation of volatile oxides and Mo-O-H compounds. At low pressures, formation of gaseous H ₂ and evaporation of volatile oxides; no surface scales, steady states with	Similar to oxygen																					
<table border="1"> <caption>Data points estimated from Fig. 16</caption> <thead> <tr> <th>Temperature [°C]</th> <th>Final mass change [mg/cm²] (He-0.5%O₂)</th> <th>Final mass change [mg/cm²] (He-Ar-H₂O)</th> </tr> </thead> <tbody> <tr> <td>400</td> <td>0</td> <td>0</td> </tr> <tr> <td>500</td> <td>0</td> <td>0</td> </tr> <tr> <td>600</td> <td>1</td> <td>1</td> </tr> <tr> <td>700</td> <td>5</td> <td>4</td> </tr> <tr> <td>800</td> <td>12</td> <td>8</td> </tr> <tr> <td>900</td> <td>18</td> <td>11</td> </tr> </tbody> </table>			Temperature [°C]	Final mass change [mg/cm²] (He-0.5%O ₂)	Final mass change [mg/cm²] (He-Ar-H ₂ O)	400	0	0	500	0	0	600	1	1	700	5	4	800	12	8	900	18	11
Temperature [°C]	Final mass change [mg/cm²] (He-0.5%O ₂)	Final mass change [mg/cm²] (He-Ar-H ₂ O)																					
400	0	0																					
500	0	0																					
600	1	1																					
700	5	4																					
800	12	8																					
900	18	11																					
Hydrocarbons	Carbon solution and carbide formation with H ₂ desorption	Carbon solution and external and/or internal carbide formation																					
Inert gas	Reduction of metal evaporation; in case of oxygen-containing impurities, formation of volatile oxides resulting in additional metal losses	Reduction of evaporation of base or alloying metals; in case of oxygen-containing impurities, oxidation processes																					
Vacuum	Degassing of H and N via H ₂ and N ₂ desorption, degassing of C and O via CO formation, degassing of O via oxide evaporation; at high residual pressures, contamination possible	Degassing processes, contamination																					

Palette of tests for the material target – and why

	Tensile testing					Charpy testing
	Fatigue testing					
	CERN	NLR	Lucideon	SincoTec	Amentum	Nordmetall
Country	Switzerland	Netherlands	United States	Germany	United Kingdom	Germany
Test types	Tensile test & Fatigue test	Tensile, Fatigue & Density	Fatigue & Tensile	Fatigue	Fatigue	Charpy impact
Samples	Open	6 Samples 2x Tensile 2x Fatigue 2x Density	6 Samples 2x Tensile (RT & HT), 6 x Fatigue (3x air 3x argon)	30 samples RT & HT, spread TBD by CERN	20 samples	46 Samples 6x Reference 40x Room → high temperature (~600 °C)
Sample geometry	Fatigue- L- 135 mm, W 100 mm	Tensile - L100 mm, G 25 mm, W 6 mm Fatigue - L 134 mm, Density- 10 mm x 10 mm x 5 mm (L x W x T)	TBD	L 160 mm, W 30 mm 16 per plate	L- 134 mm, W30 mm	10 mm x 10 mm x 55 mm
Machining	EDM-CERN	EDM-CERN	EDM-CERN	Machined-SincoTec	EDM-CERN	EDM-CERN
Machine parameters	Testing up to 20 Hz	Testing up to 100 Hz	Frequency to be determined	Testing up to 80Hz	Testing up to 20 Hz	Testing in increasing increments from room temperature to 600 °C
Heating & atmosphere	Room temperature only in atmosphere	Furnace heated in argon oven (Experienced in this testing)	Information not given	Induction heating in argon test chamber. (Experience in this testing)	Furnace heated (including grips) Static argon during test (no experience in this testing)	Information not given
Duration	6 days per sample fatigue	12 days	11-12 weeks	~ 6-7 weeks	17 weeks	4 weeks
Price	EDM cost only	€40, 400.00	£23,280.00	€51,786.00	£104,681.11	€4,600.00

Palette of tests for the material target – and why

Previous work: Cladding

- HIP has been proven as a valid technique to bond W to Ta and W to W (through a Ta interfoil): erosion-corrosion resistant claddings in representative geometries of the final target

Homogeneous bonding

- With stronger interfaces and theoretical thermal conductivities were achieved in Ta-TZM, Ta-W, and Ta2.5W-TZM. Ta2.5W-W showed 70% of the cladding material's strength [1] [2]
- Checked by NDT, microstructural and mechanical characterization on unirradiated and irradiated components



HIP cladding ↑
Other methods like CVD and sleeve-in were unsuccessful

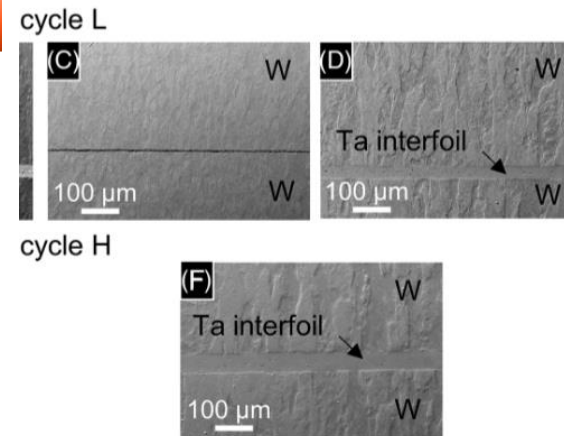
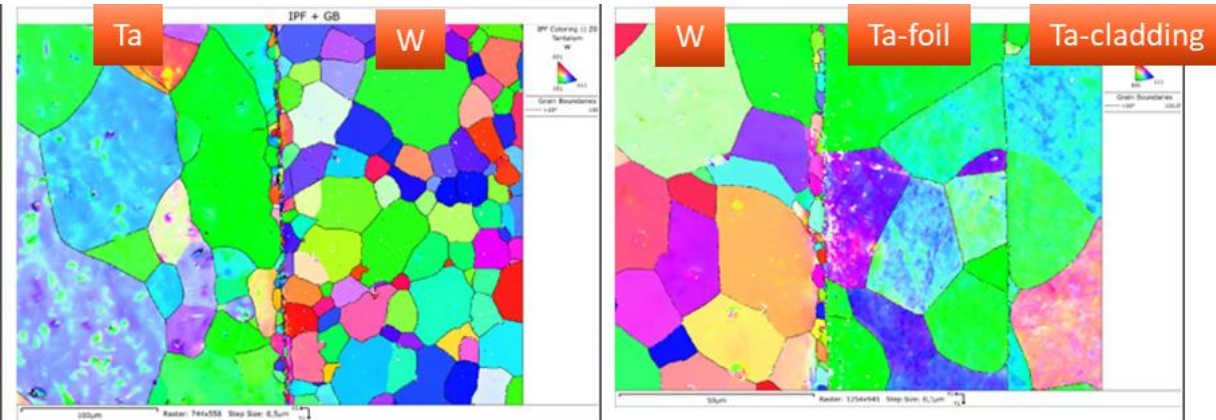


Ta-cladding by HIPing exhibited reliable and good bonding quality (Ta to W with and without foils and W/Ta/W)

Robust heat transfer from core to cooling water



More studies are needed to complete assessment mechanical strength



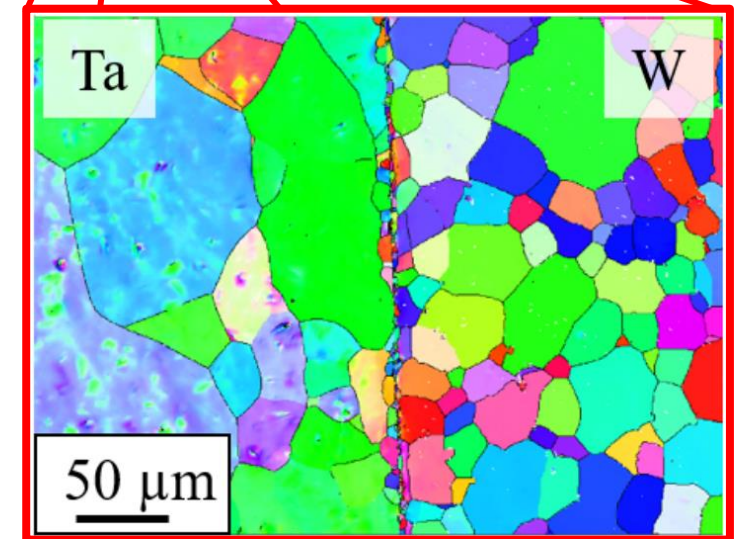
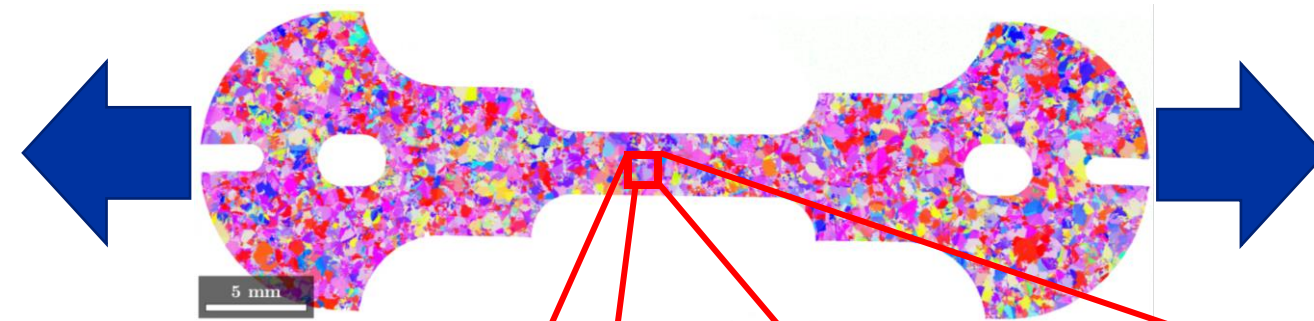
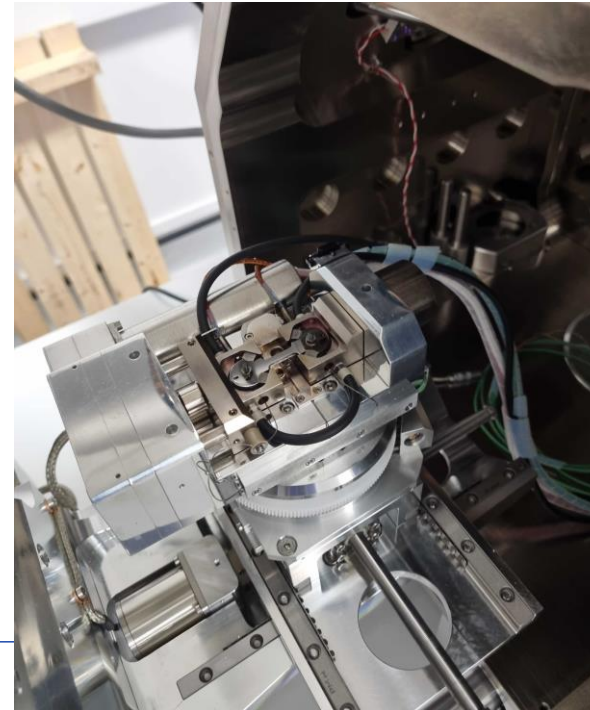
[1] 2018 → Recent developments on the application of Hot Isostatic Pressing (HIP) technologies for proton beam targets at CERN with Fraunhofer [J. Busom et al.](#)

[2] 2024 → PIE of a prototype tantalum-clad target in collaboration with Framatome [T. Griesemer et al.](#)

Palette of tests for the material target – and why

In-situ proposal

- Collaboration with the University of Manchester, experts in this field
- Mechanical testing inside SEM
- Well adapted to test interfaces (W/Ta/W)
- **RT and high temperature in-situ**
- **SEM vacuum environment**
- Cost: \approx 6000 CHF per test



Palette of tests for the material target – and why

Profilometry – based indentation plastometry

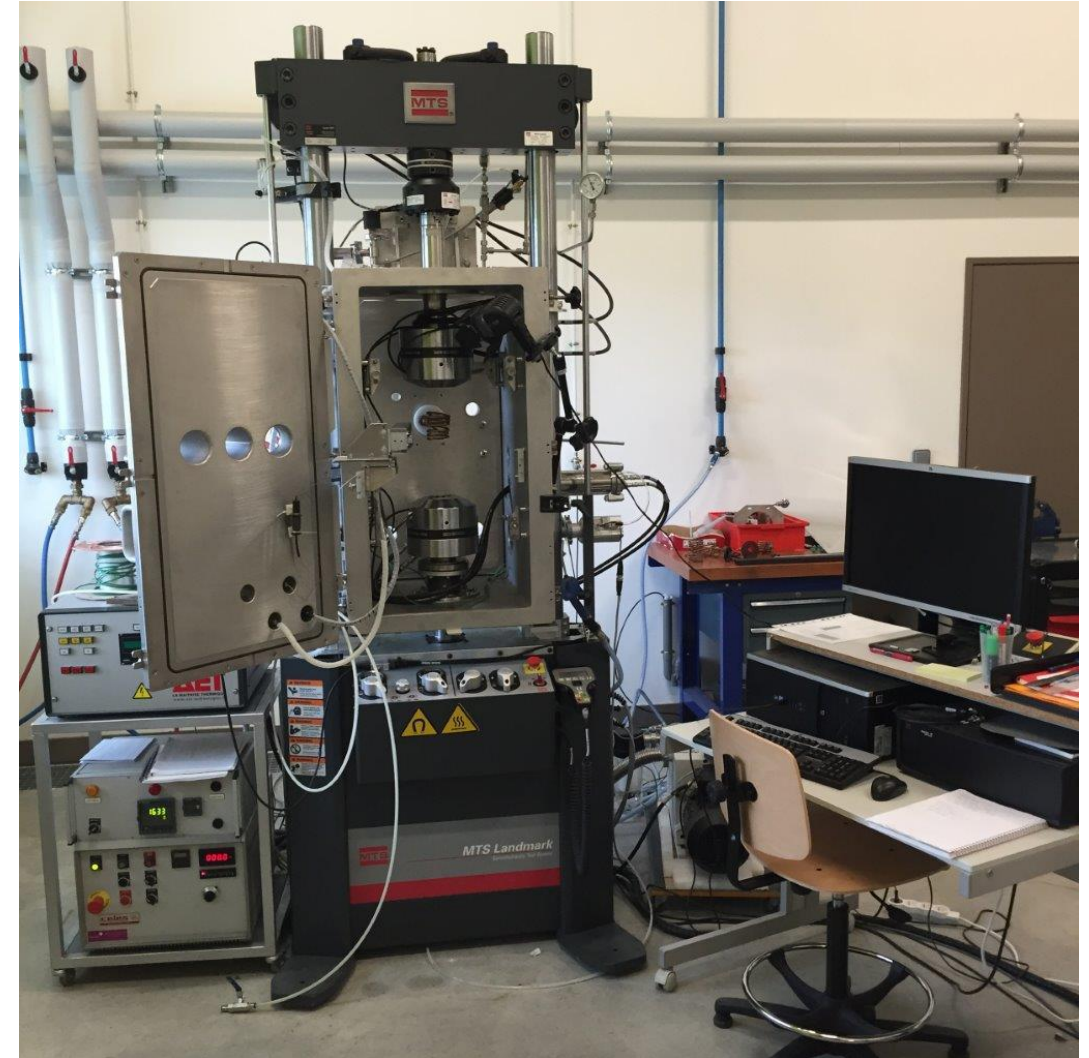


- The system allows obtaining stress–strain curves (up to uniform elongation) **based on indentation + profilometry data**
- We (EN-MME) have benchmarked it with a ‘blind test’ on a variety of materials (stainless steel P506, Nb RRR 300, electroformed Cu) with very consistent results (difference in $R_{p0.2}$ and $R_m < 10\%$)
- The HT option has been validated for pure tungsten up to 800°C
- **Estimated 131 kCHF**
- In-SEM also being evaluated for specific tests (collaboration Prof. Kermouche / Ecole des Mines de Saint Etienne) and own equipment (200 kCHF)

Palette of tests for the material target – and why

High T (1200°C) + vacuum Universal Testing System

- Scarce availability
- High (and highly scattered) cost of high cycle fatigue testing at high temperature under vacuum or protective atmosphere
- Equip ourselves with state-of-the-art HT fatigue testing device?
- Two potential suppliers: Instron /UK & MTS/USA
- Both suppliers work with a French partner which is a reference of vacuum furnaces: AET
- Seamless integration with the unit, vacuum environment to avoid oxidation, and the whole specimen is at HT
- The system could eventually be installed in an extension of our current mechanical testing laboratory
- Both machine and vacuum furnace would be in the range of **550 – 600 kCHF**, including grips and extensometers



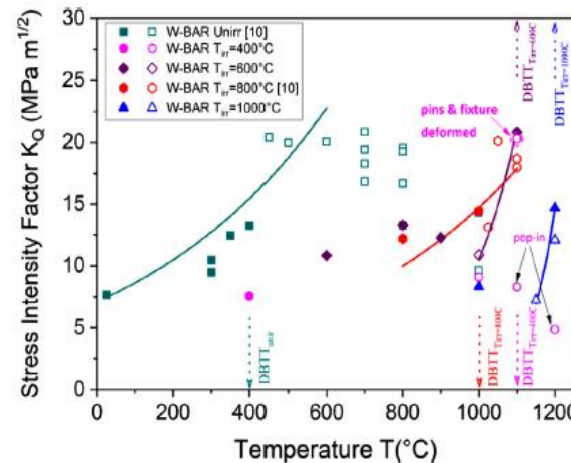
Radiation damage considerations on materials – do we care?

General outcome: increase in the DBTT of irradiated samples

- The increase of the DBTT depends on fluence and irradiation temperature & it is pronounced even for doses as low as ~1 dpa
- Early works report DBTT of sintered unirradiated W ~ 400°C and of irradiated W ~ 600°C (ITER Materials Assessment Report (MAR), ITER Doc. G 74 MA 10 01-07-11 W0.3)
- Recent works confirm that irradiation strongly impacts the fracture-mechanical behaviour of wrought W irradiated to 1 dpa
- Depending on the irradiation temperature, the DBTT increases by about 650 °C or even higher

DBTT and Δ DBTT of IGP-W bar. The scattering of unirradiated DBTT values reflects the difference in the DBTTs determined on KLST (10) and on DCT (13) specimens, see text. The results for the unirradiated state and 1dpa@800°C are from (10).

Condition	DBTT (°C)	Δ DBTT (°C)
Unirradiated	400-450	-
1dpa@400°C	1100	650
1dpa@600°C	≥ 1100	≥ 650
1dpa@800°C	1000-1025	600-625
1dpa@1000°C	≥ 1200	≥ 750



Gaganidze E., et al (2021). Effect of irradiation temperature on the fracture-mechanical behaviour of tungsten irradiated to 1 dpa, *Journal of Nuclear Materials*, 556
<https://doi.org/10.1016/j.jnucmat.2021.153200>

- Tungsten wires irradiated at 0.2, 1, and 10 dpa and tested at RT. No significant change in the ductility of both irradiated and non-irradiated wires was found - Lürbke, R. et al. (2025), <https://doi.org/10.1016/j.nme.2024.101858>

Conclusions

- The selected metallurgical route, form of product (HR plates), HIP diffusion bonding techniques are promising, based on previous assessments and ongoing tests
- However, an extensive material characterisation and assessment of mechanical properties at intermediate temperature is still needed to support this material choice
- Testing campaigns are extensive, complex and costly → consider developing in-house test facilities
- Critical points are the limitation of the thickness: a HIP cycle required, equivalent to an annealing, that might raise the DBTT
- Irradiation hardening and embrittlement are potential concerns (primary degradation phenomena of W):
 - hardness and yield strength increase, ductility loss at high doses, shift of DBTT
 - Large DBTT shift expected even at a low dose of 1 dpa
 - Brittle regime in all temperature range eventually expected, no self-recovery
- Thermomechanical processing techniques, such as rolling and forging and/or additives/dopants can reduce the DBTT of W, even down to RT. Nevertheless, both approaches have proven to be less effective when W is subjected to high-temperature annealing or irradiation



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